APR 2 6 2004

INFORMATION DISCLOSURE STATEMENT Docket: EWG-097 Ser. 1

Ser. No. 09/746,671

Applicant: Davidson et al.

Filed: December 22, 2000 Group: 2621

6542260	4/1/03	Gann et al.	358/47/
6590996	7/8/03	Reed et al.	382/100
6614914	9/2/03	Rhoads et al.	382/100
6631015	10/7/03	Rhoads	358/497
6647130	11/11/03	Rhoads	384100
6690389	2/10/04	Ulichney	345/69/
6700995	3/2/04	Reed	345/691
6707578	3/16/04	Bradburn	358 13.07
6721440	4/13/04	Reed et al.	384100
20010038755	11/8/01	Ishihara	396/321
20010045957	11/29/01	Ulichney	345/596
20020063724	5/30/02	Powers et al	345/624
20020126147	9/12/02	Lavendel	345/764
20030020932	1/30/03	Youngers	358/1.4
20030020933	1/30/03	Youngers	35811.9
20030043394	3/6/03	Kuwata et al.	358/1.9
20030101289	5/29/03	Alikberov et al.	358/1.4
20030177448	9/18/03	Levine et al.	7151530
20040062438	4/1/04	Jia	352/169
<u> </u>	Foreign Patent D	ocuments	
Number	Date	Inventor	Class
EP1156662	11/21/01	Matsui	HO4N 1/38
1	Other Defer	ences	
r	Other Refer		
		Cite	
TWAIN Specificat			ry 20, 2000, 550
		Cite	ry 20, 2000, 550
TWAIN Specificat		Cite	ry 20, 2000, 550
	6590996 6614914 6631015 6647130 6690389 6700995 6707578 6721440 20010038755 20010045957 20020063724 20020126147 20030020932 20030020933 20030043394 20030101289 20030177448 20040062438	6590996 7/8/03 6614914 9/2/03 6631015 10/7/03 6647130 11/11/03 6690389 2/10/04 6700995 3/2/04 6707578 3/16/04 6721440 4/13/04 20010038755 11/8/01 20020063724 5/30/02 20020126147 9/12/02 20030020932 1/30/03 20030020933 1/30/03 20030043394 3/6/03 20030177448 9/18/03 20040062438 4/1/04 Foreign Patent D Number Date EP1156662 11/21/01	6590996 7/8/03 Reed et al. 6614914 9/2/03 Rhoads et al. 6631015 10/7/03 Rhoads 6647130 11/11/03 Rhoads 6690389 2/10/04 Ulichney 6700995 3/2/04 Reed 6707578 3/16/04 Bradburn 6721440 4/13/04 Reed et al. 20010038755 11/8/01 Ishihara 20010045957 11/29/01 Ulichney 20020063724 5/30/02 Powers et al 20020126147 9/12/02 Lavendel 20030020932 1/30/03 Youngers 20030020933 1/30/03 Youngers 20030043394 3/6/03 Kuwata et al. 20030177448 9/18/03 Levine et al. 20040062438 4/1/04 Jia Foreign Patent Documents Number Inventor

Examiner Signature: 3. Waklipuran]

Date Considered: 7-11-04

^{*}Examiner: Initial if considered, whether or not in conformance with MPEP 609; draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.

INFORMATION DISCLOSURE STATEMENT

Docket: EWG-097 Ser. No. 09/746,671

Applicant: Davidson et al.

Filed: December 22, 2000 Group: 2621

US Patent Documents						
Ex'r Initial	Number	Date	Inventor	Class		
5.2	60/173880	12/31/99	Davidson			
1	4937682	6/26/90	Dalton	358/461		
	5113455	5/12/92	Scott	384298		
	5185673	2/9/93	Sobol	358/296		
	5220432	6/15/93	Roe et al.	358/534		
	5243655	9/7/93	Wang	33951		
	5304786	4/19/94	Pavlidis et al.	235/462.0		
	5315098	5/24/94	Tow	235/494		
1	5333064	7/26/94	Seidner et al.	3 58/3.00		
	5553171	9/3/96	Lin et al.	384299		
i	5687236	11/11/97	Moskowitz et al.	380/18		
	5719965	2/17/98	Degi et al.	382/254		
	5721788	2/24/98	Powell et al.	3521100		
	5771317	6/23/98	Edgar	382/260		
	5778105	7/7/98	Shively	382/269		
	5856832	1/5/99	Pakenham et al.	3451540		
	5862260	1/19/99	Rhoads	382/232		
1	5881162	3/9/99	Ishimitsu	382/137		
-	5901243	5/4/99	Beretta	382/163		
	5907665	5/25/99	Sobol et al.	35811.9		
	5915027	6/22/99	Cox et al.	380154		
	5920407	7/6/99	Erickson et al.	358/504		
	5930410	7/27/99	Webb et al.	3843/2		
	5946414	8/31/99	Cass et al.	382/183		
	5974548	10/26/99	Adams	382/183		
	5999175	12/7/99	Nalder	7/3/200		
	6094689	7/25/00	Embry et al.	345/766		
	6104812	8/15/00	Koltai et al.	71015		
	6172681	1/9/01	Ueda	3451589		
	6229924	5/8/01	Rhoads et al.	382/232		
	6334187	12/25/01	Kadano	7/3/174		
	6374036	4/16/02	Ryan et al.	386/44		
	6442284	8/27/02	Gustafson et al.	382110		
	6462756	10/8/02	Hansen et al.	345/764		
	6493517	12/10/02	Hanson	349/11		
4	6518587	2/11/03	Rombola	2501559.1		

Examiner Signature: Date Considered: 7-11-04

^{*}Examiner: Initial if considered, whether or not in conformance with MPEP 609; draw line through cite if not in conformance and not considered. Include copy of this form with next communication to applicant.